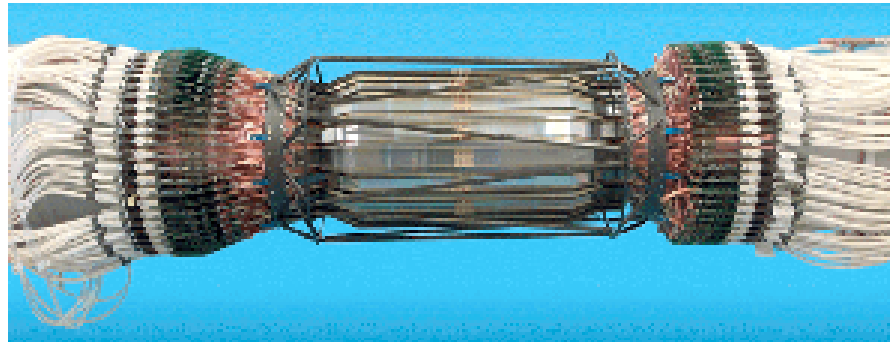


# Status and future plans of the BaBar Silicon Vertex Tracker

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**Representing the BaBar SVT Group**



The 11th International Workshop on Vertex Detectors  
Kailua-Kona, Hawaii, USA  
4 November 2002



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# Outline



- Description and Features
- Status, improvements, and future plans...
  - Radiation hardness, monitoring and protection
  - Internal alignment
  - Shutdown activities

# Design Requirements

## Physics Requirements

- $\Delta z$  resolution  $< 130 \mu m$
- *single vertex* resolution  $< 80 \mu m$
- stand-alone tracking for particles with low transverse momentum ( $p_t < 120 MeV/c$ )

*Much higher luminosity than originally planned!*

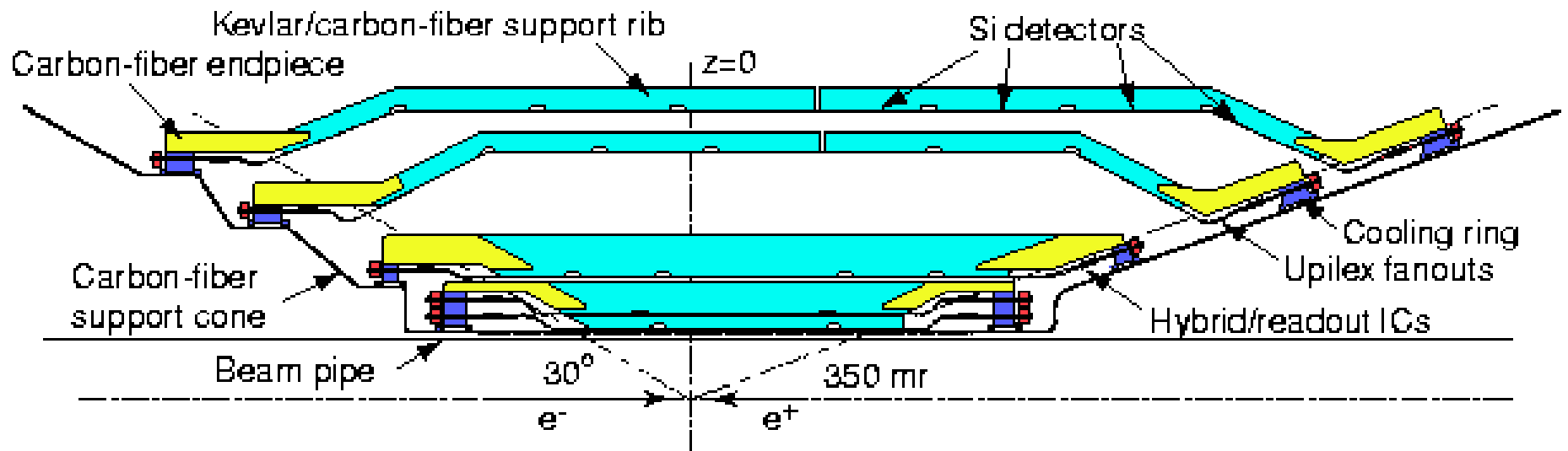
## PEP II Constraints

- permanent dipole magnets  $\pm 20 cm$  from the IP
  - || polar angle  $17.2^\circ < \theta < 150^\circ$
  - || SVT is mounted on the magnets
- bunch crossing  $4.2 ns$  ( $\sim 238 MHz$ )
- radiation at inner layers (estimated)
  - average  $33 kRad/yr$
  - bend plane  $240 kRad/yr$

### **based on recent extrapolations**

average  $250 \text{--} 400 kRad/yr$   
bend plane  $1000 \text{--} 2000 kRad/yr$

# The BaBar SVT



- **5 layers** of double-sided, AC coupled silicon wafers

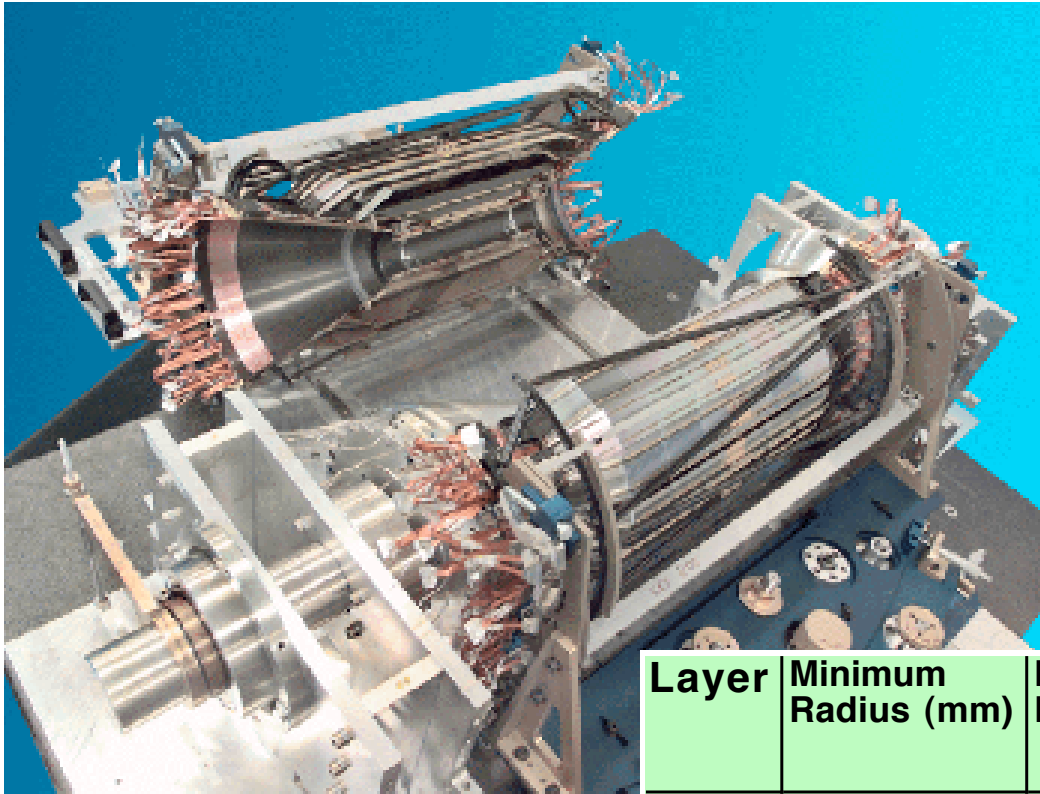
## Inner layers (1-3)

- **vertexing** information (angle, impact parameter)
- hit resolution  $10 \times 15 \mu m$

## Outer layers (4-5)

- **tracking** and pattern recognition
- hit resolution  $30 \times 40 \mu m$

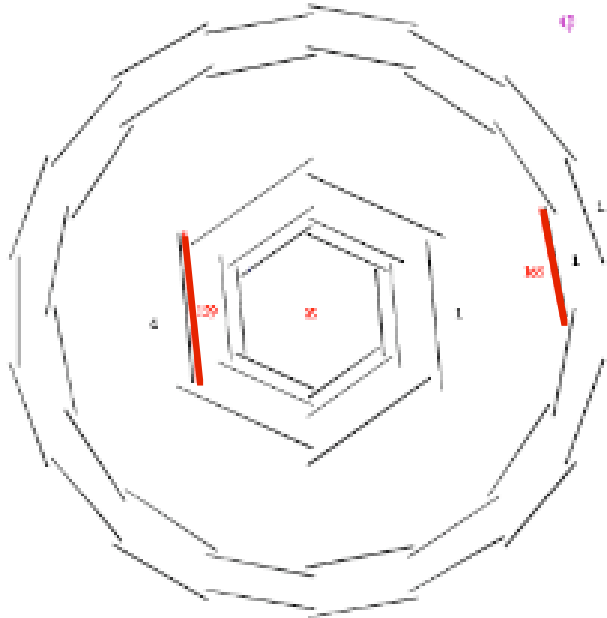
# Specifications



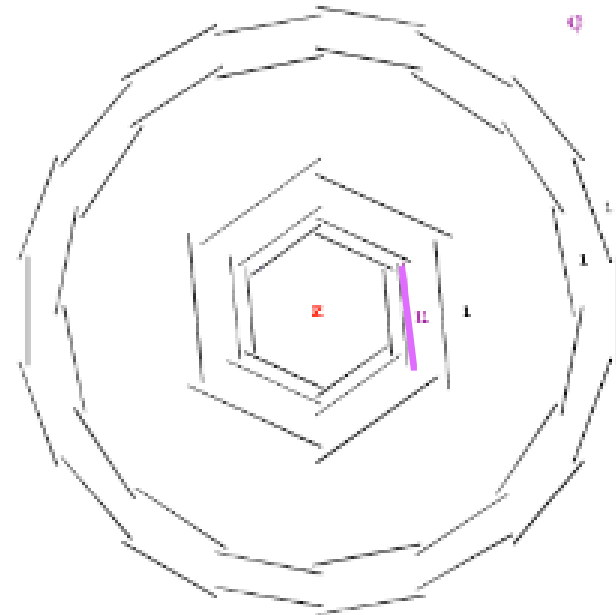
Layer	Minimum Radius (mm)	Modules/ Layer	Wafers/ Module	$\phi$ pitch ( $\mu\text{m}$ ) (readout)	$z$ pitch ( $\mu\text{m}$ ) (readout)
1	32	6	4	50-100	100
2	40	6	4	55-110	100
3	54	6	6	110	100
4	124	16	7	100-82	210
5	140	18	8	100-82	210

# Module Status

Forward



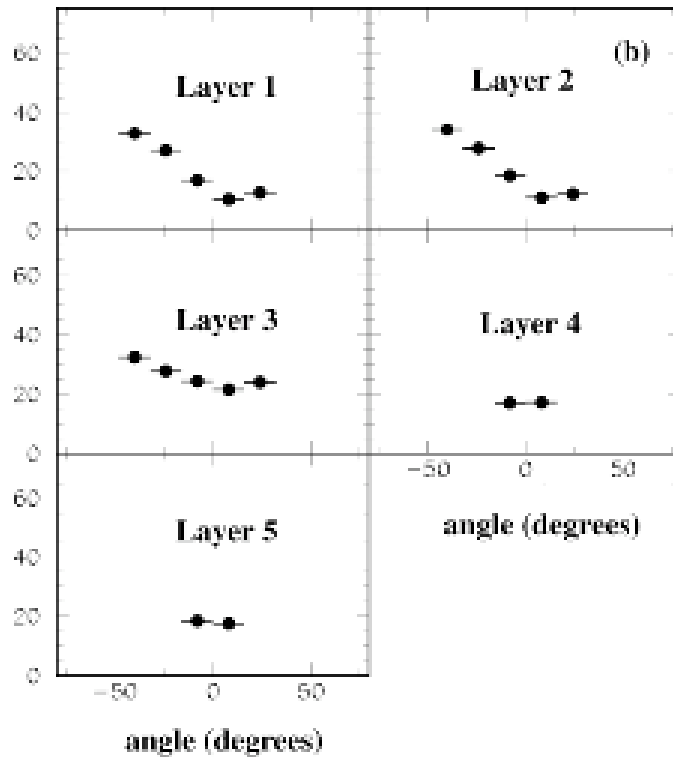
Backward



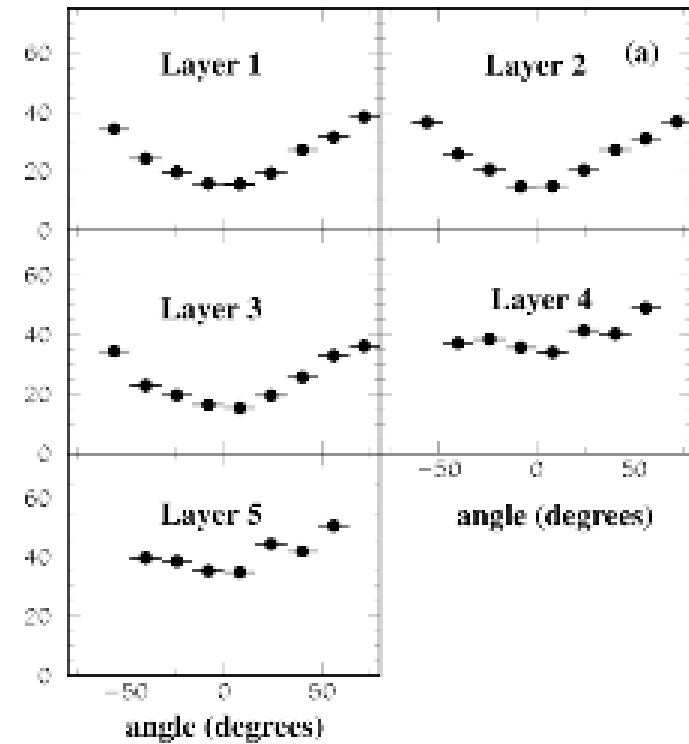
- 104 half-modules, 208 readout sections
- **only 3 sections are not read-out**  
(6 were fixed this summer, more later...)
- no sections lost to radiation damage

# Resolution

$\square$  Resolution ( $\mu m$ )



$z$  Resolution ( $\mu m$ )

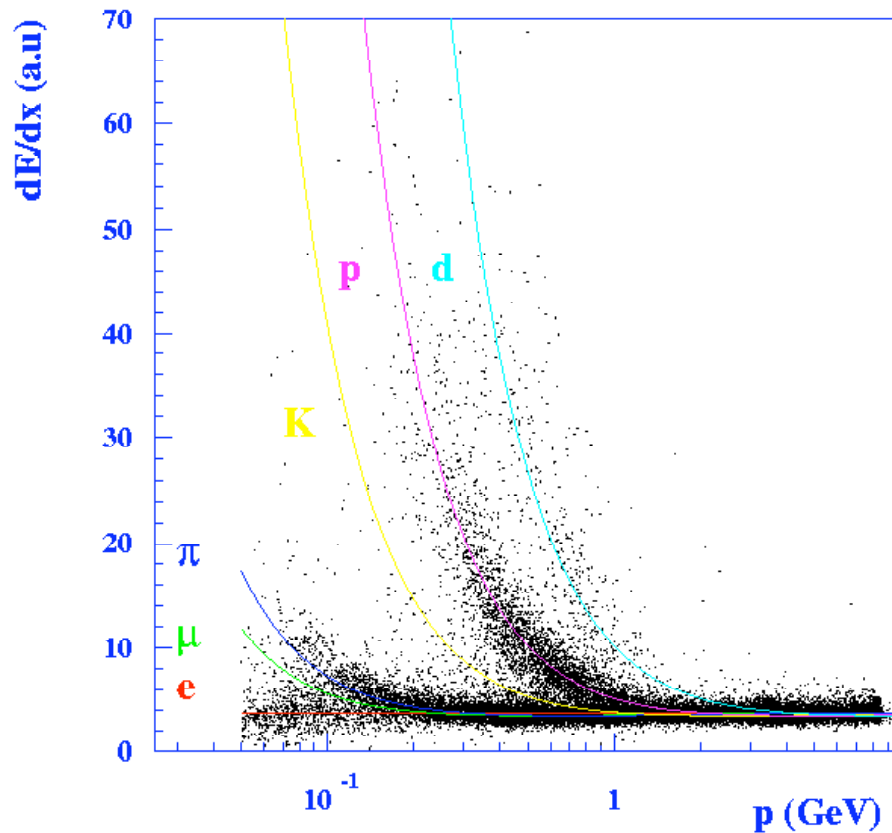


Meets TDR specifications for perpendicular tracks

- layers 1-3 10  $\square$  15  $\mu m$
- layers 4-5 30  $\square$  40  $\mu m$

# Particle ID

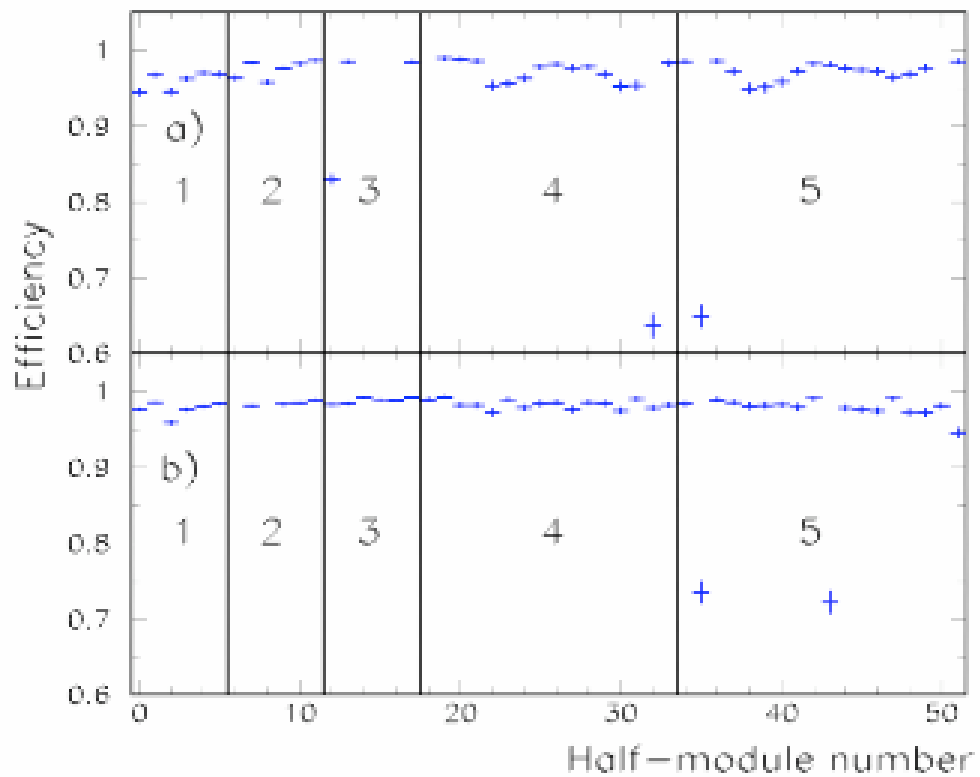
## SVT dE/dx versus momentum



- Use pulse height measurement to determine ionization  $dE/dx$
- $2\sigma$  separation between  $K$  and  $\pi$  up to 500 MeV/c,  $K$  and protons up to 1 GeV/c

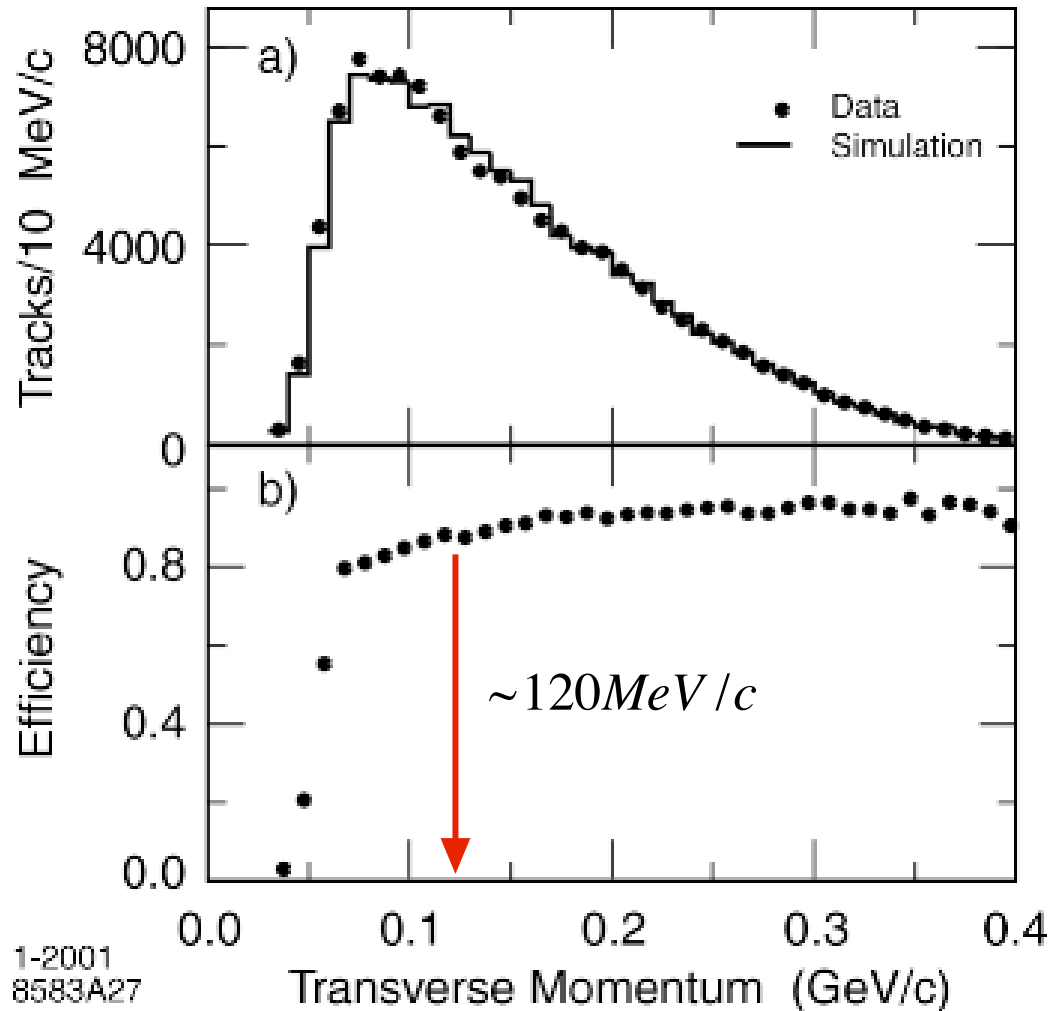


# Efficiency



- Hit reconstruction efficiency is typically  $> 98\%$

# Tracking



- slow pion detection efficiency with both SVT and Drift Chamber
- SVT significantly extends charged particle detection down to  $\sim 50 \text{ MeV}/c$
- Important for  $D^{*+} \rightarrow D^0 \pi^+$

1-2001  
8583A27

# A Year Older...

## Radiation Good News

- Tests indicate that **the SVT is Rad Hard up to 5Mrad**
- Our detector is more radiation hard than our background sensors!

## A Reunion

- BaBar shutdown from July 1 -- Nov 15
- The SVT came out, but it was **not** disassembled. **We were able to restore 6 readout sections!** (only 3 remain unused)

## Alignment Successes

- **Improved algorithms make SVT local alignment accurate and fast**
- Able to detect and correct for shift of layers 4 and 5 (why did they shift, you ask...)

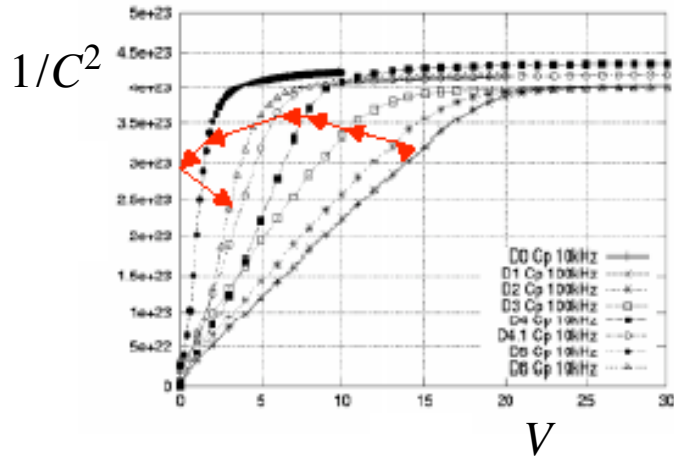
# Radiation Tests

- *SVT originally designed for 2 MRad total* over the lifetime of the detector (~10 years)
- The inner layers in the bend plane will receive **~5 MRad by 2005**
- Tests indicate that the **SVT is OK up to 5 Mrad**
  - silicon wafers OK  
(increased noise, type inversion)
  - front-end electronics (ATOM chips) OK  
(decreased gain, increased noise, no digital failures)
- Still need to do test of charge collection efficiency after type inversion (silicon + readout-chain)

# Silicon Radiation Tests

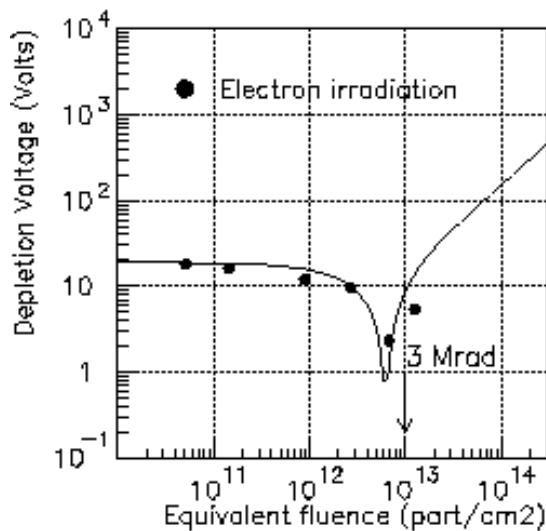
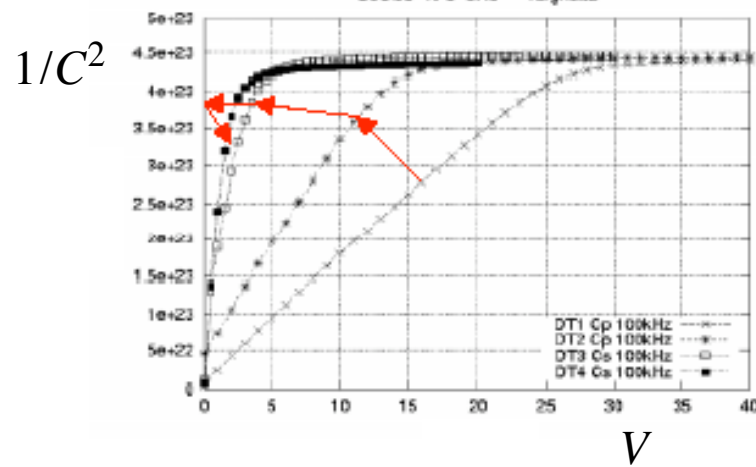
electron beam

SD3.06 TF3 GRD - Elettra



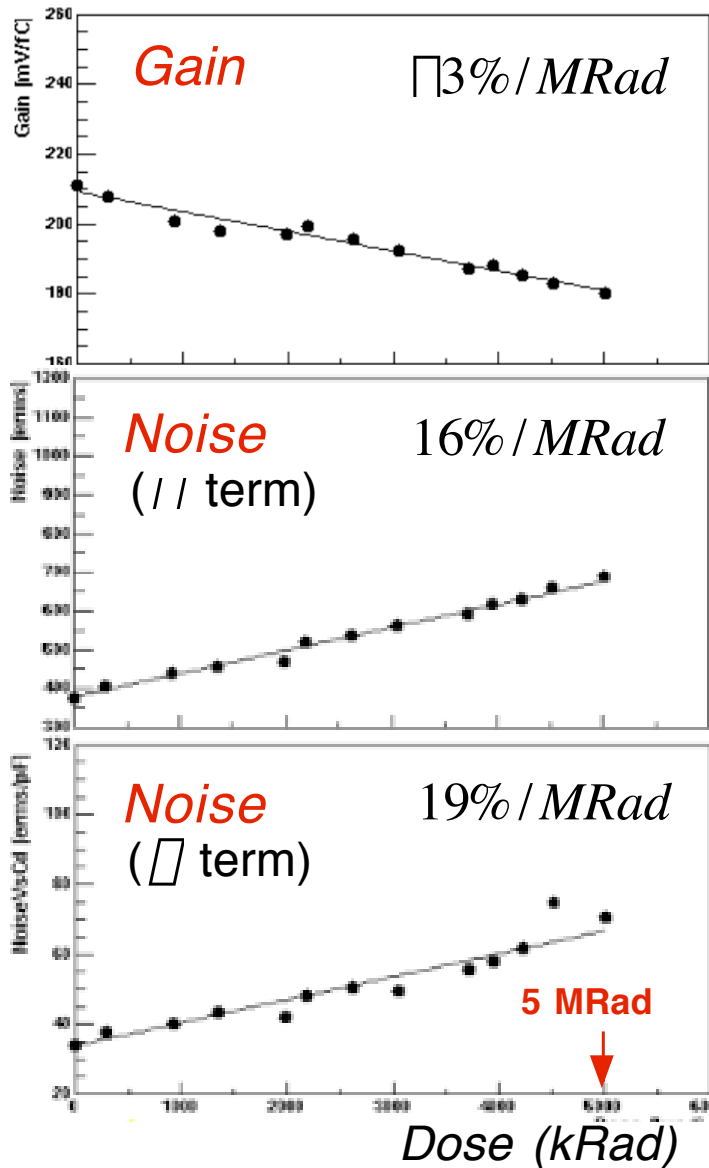
electron beam on Cu target

SD3.03 TF3 GRD - Targhetta



- shows type inversion  $\sim 2 \square 3 \text{MRad}$
- results agree with NIEL hypothesis (not obvious or expected)
- leakage current increase  $\sim 2 \square \text{A} / \text{MRad} \square \text{cm}^2$
- Agrees with in-situ measurements

# Front-end (ATOM) Radiation Tests

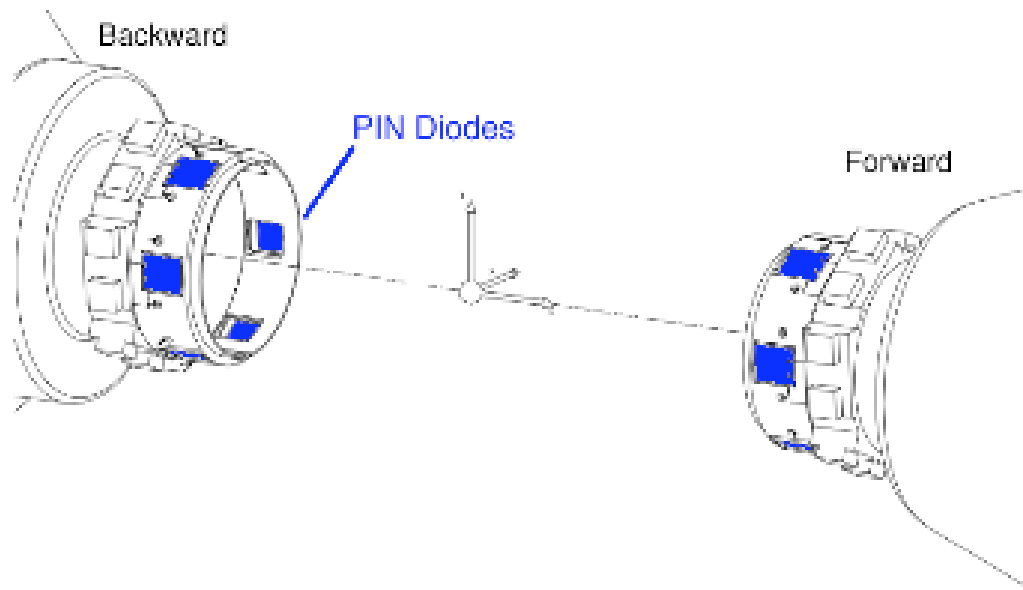


- Tests performed with  $Co^{60}$  source at LBL and SLAC
- Chips powered and running during irradiation
- No digital failures up to 5 MRad

$$Noise = \square + \square C_{load}$$

Significant decrease in performance of inner layers around 5MRad (S/N  $\sim$  10)

# Radiation Sensors



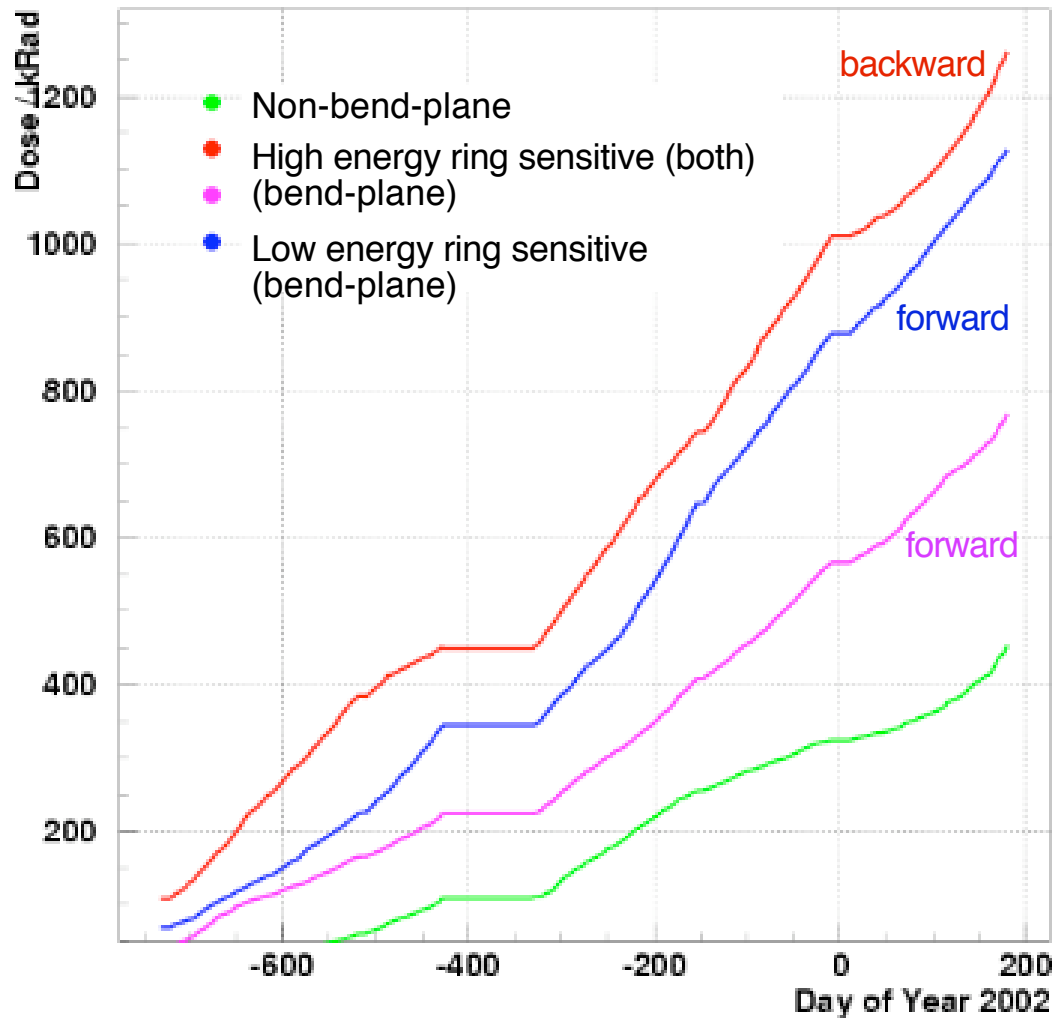
- 12 reversed-biased PIN diodes
- 1cm x 1cm x 0.03 cm active area per diode
- 1mRad ~ 200pC
- **Used for both monitoring and protection**

- Most irradiated diodes > 1MRad
- Leakage currents ~ 1000-2000nA
- Typical signals ~ 2-4nA
- Temperature correction ~ 10%/deg C

Increasingly difficult to measure background conditions accurately!

# Radiation Monitoring

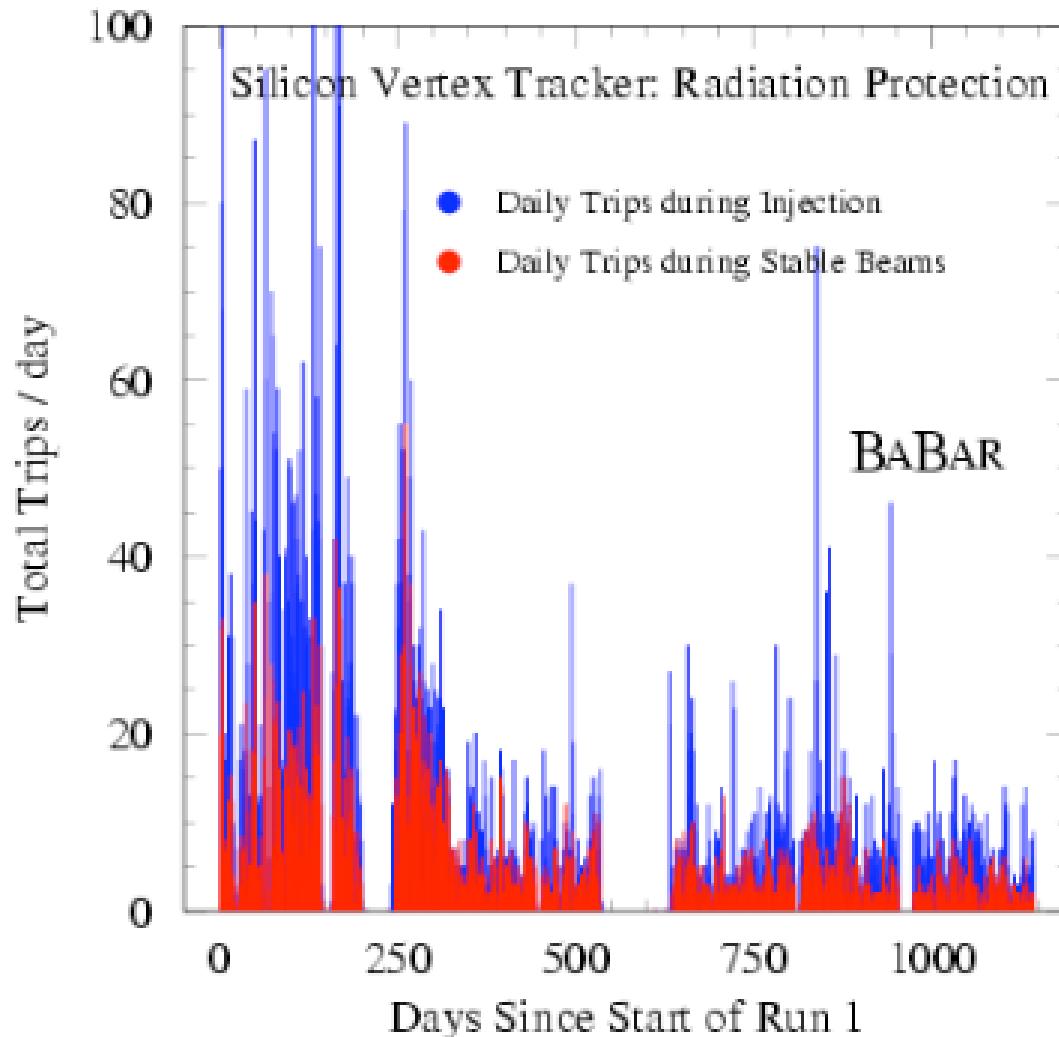
SVT PIN Diode Accumulated Dose



- Most damaged areas in the bend plane ~1.2MRad
- Typical “non-bend-plane” diode ~ 400kRad



# Radiation Protection



- 4 bend plane (AKA “mid-plane”) diodes used in abort logic
- We have both a “fast abort” (hardware  $\sim 400\mu\text{s}$ ) and a “slow abort” (several minutes)
- dose rate thresholds  $\sim 1000\text{mR/s}$  (starting June 2002)
- **No major damage due to radiation since installation!**

# Radiation Monitoring Upgrades

- *Cannot replace PIN diodes without removing the entire SVT*
- Use PIN diodes without bias? (short-term)
  - Response decreases significantly with increased accumulated dose
  - Probably makes dose estimates even worse
- Readout electronics upgrade (medium-term)
  - continuously measure the leakage current using the ion-clearing gap ( $\sim 400\text{ns}$  every  $7.3\mu\text{s}$ )
- New sensors (long-term)
  - **replace PIN diodes with diamond sensors**
  - currently performing tests...

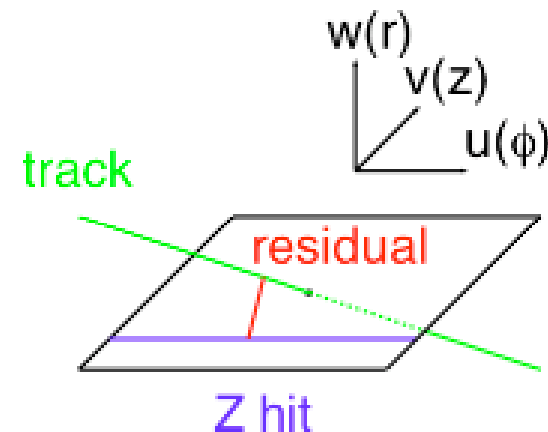
# SVT Alignment

Two types of alignment: **global** (SVT with respect to BaBar) and **local** (internal alignment)

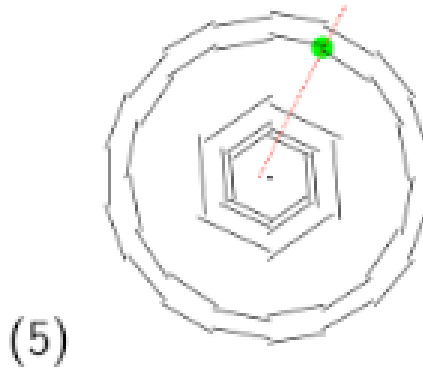
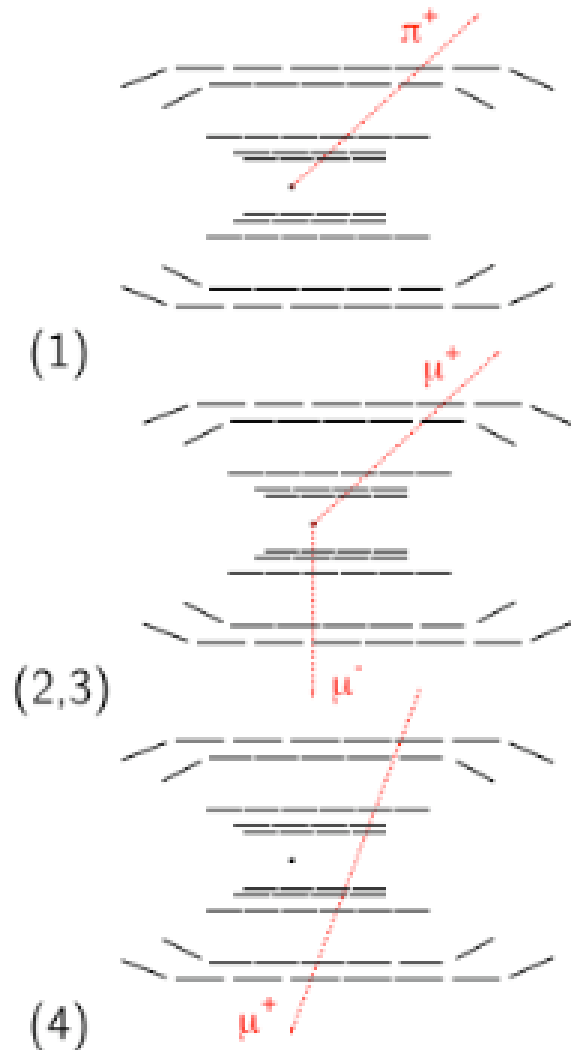
- Global alignment (SVT with Drift Chamber) is done run-to-run (has worked well for years)
- Local alignment has been improving each year  
**Many new improvements in the last year!**

## *SVT Local Alignment*

- Each of 340 wafers described by 6 parameters + *curvature*
- Calculate residuals, minimize  $\chi^2$



# Track/Hit Selection



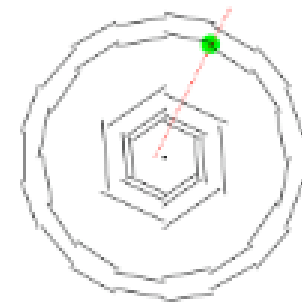
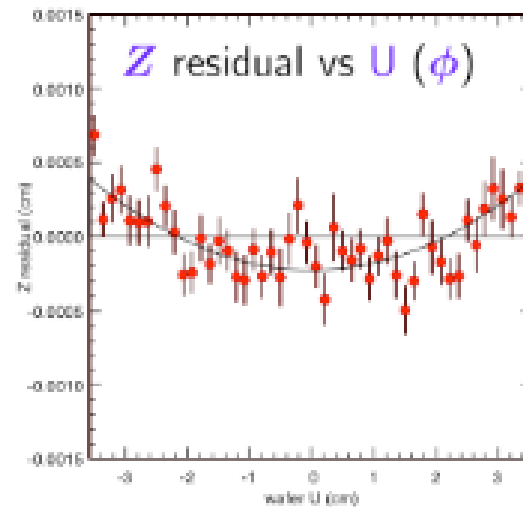
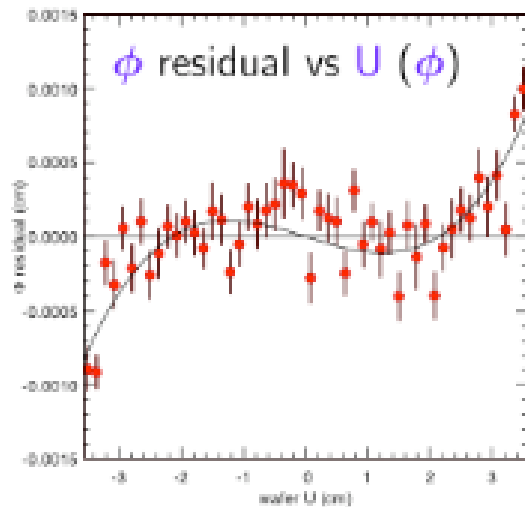
## *categories of tracks used*

1. "normal"
2.  $\mu^+\mu^-$
3.  $e^+e^-$
4. cosmics
5. tracks with overlap hits

- choose tracks distributed uniformly over detector, categories
- select  $\sim 50,000$  tracks, use  $\sim 3-4$  hits/track

# Latest Improvements

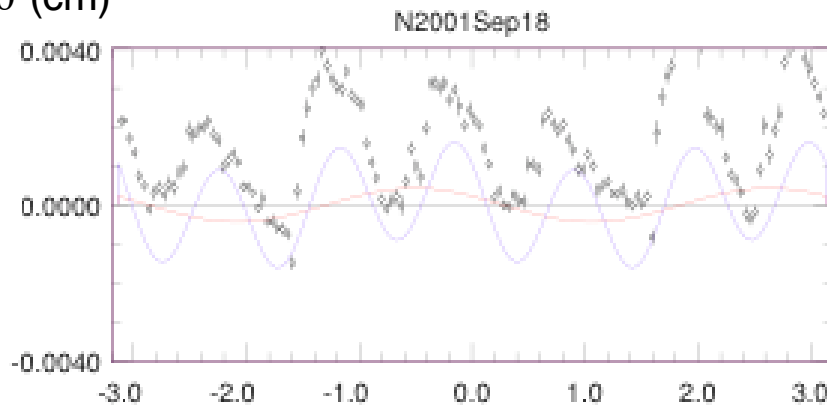
- New database format-- the “mini”
  - Used to use raw data to get individual SVT hits
  - The process would take weeks; now it takes about a day!
- Re-written algorithm, more flexible (allowing new track categories to be added easily...)
- Allows individual wafer curvature



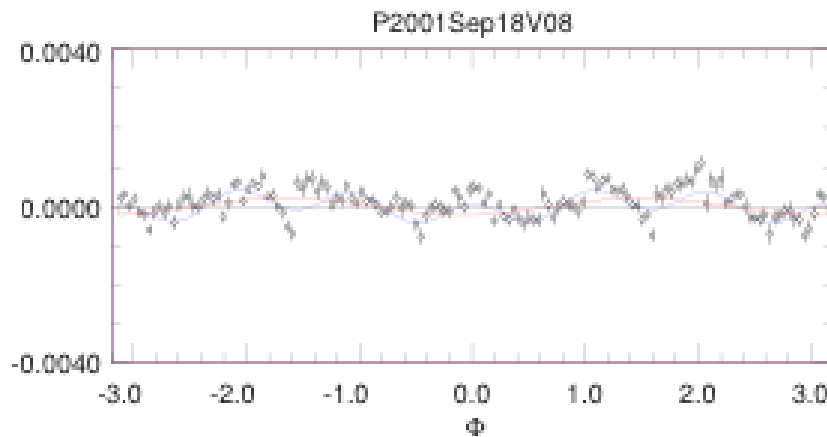
# Mu-pair misdistance

distance between  $\mu^+\mu^-$  tracks produced at the IP  
as a function of  $\Phi$

$\Delta d_0$  (cm)



← *old alignment*

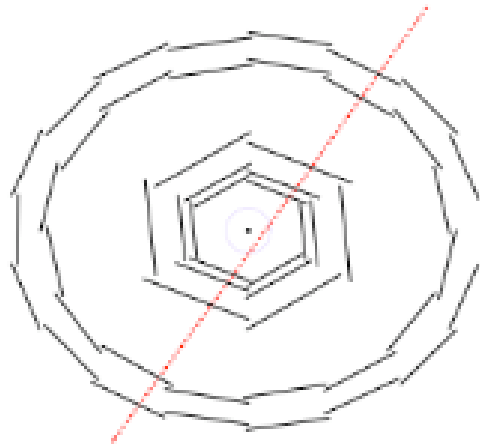


← *new alignment!*

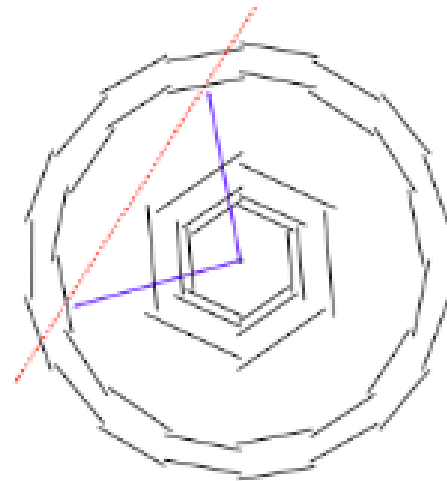
# Further Improvements

- Currently, there is only a weak constraint on *elliptical bias*
- Present trigger only keeps tracks near IP
- Need tracks connecting wafers at  $\pi/2$
- Trigger changed sometime soon...

Present L3 Cosmics

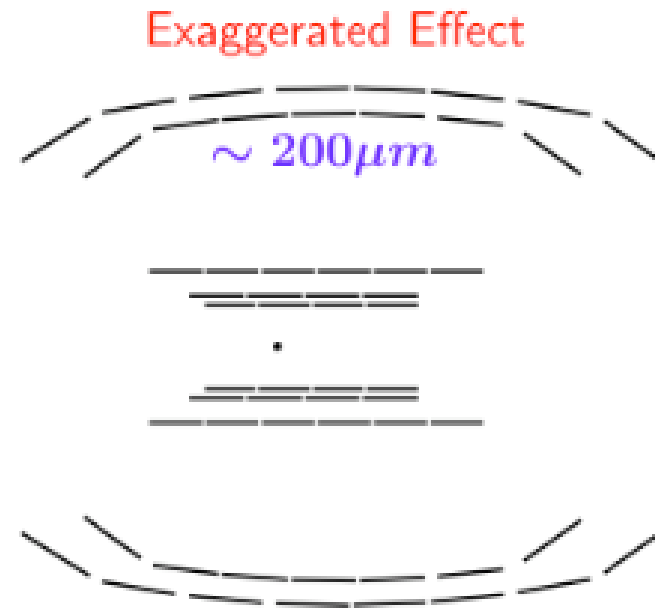
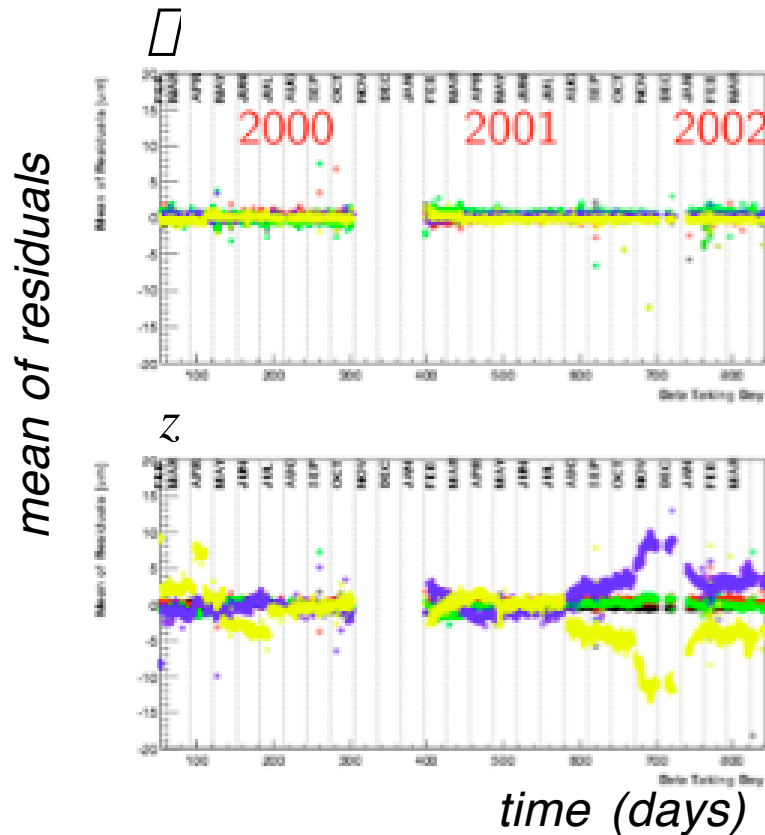


Cosmics we need



# Alignment Monitoring

- Change in relative humidity near SVT caused slight expansion of layers 4 and 5
- Noticed change in mean and width of residual distributions, calculated new alignment parameters

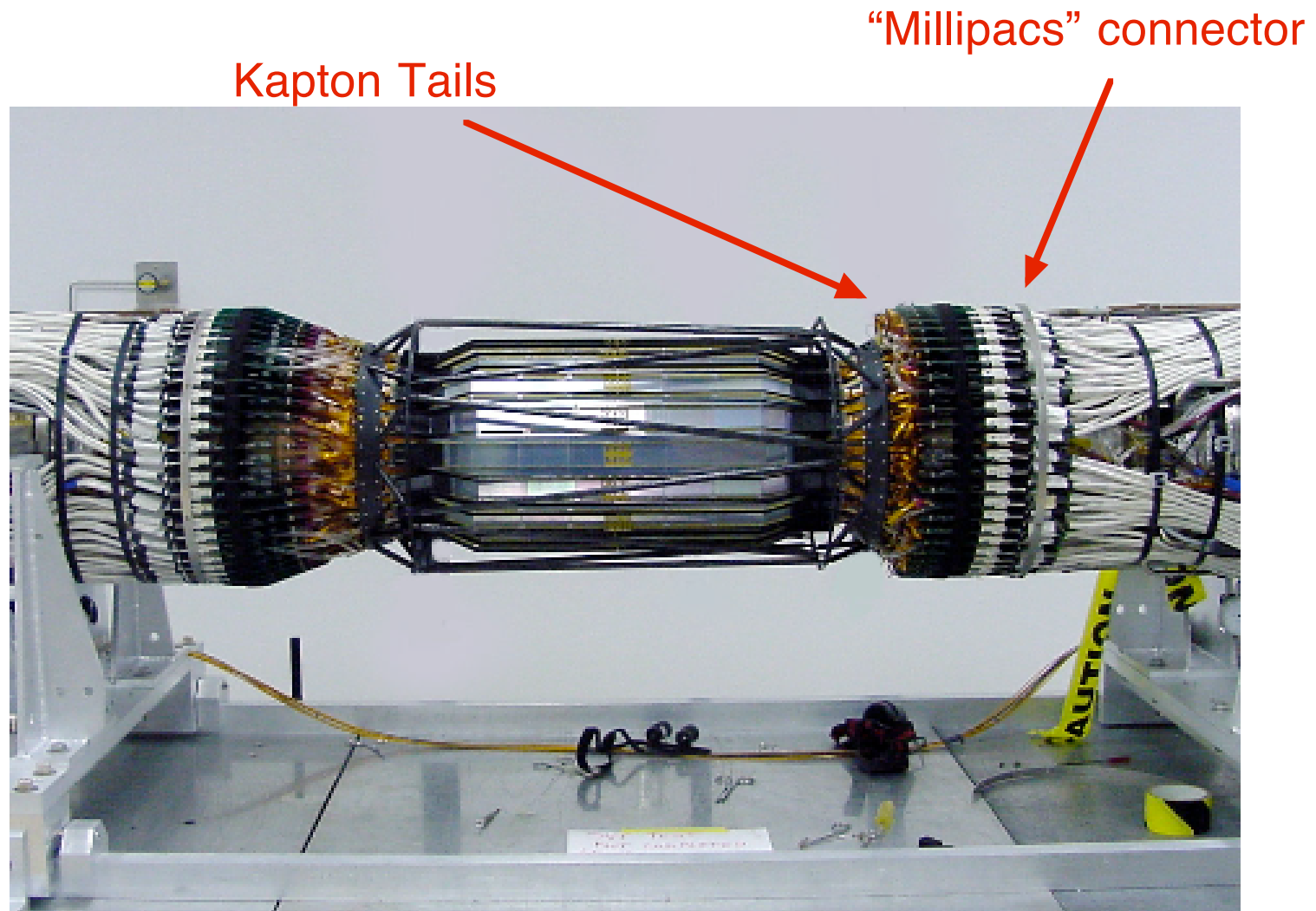




# Summer Shutdown

- BaBar shutdown July 1 -- Nov 15, 2002
  - Upgraded/repaired muon detector
  - Installed more cooling to bellows near IP to allow higher luminosity
    - || **Removed the SVT!**
- Restored 6 readout sections!
  - 1 half-module (2 readout sections) could not hold bias fixed itself!
  - 4 readout sections were not connected properly!
- No major work done on SVT (would require another 1.5 months)
- Tried not to break anything

# SVT in Clean Room



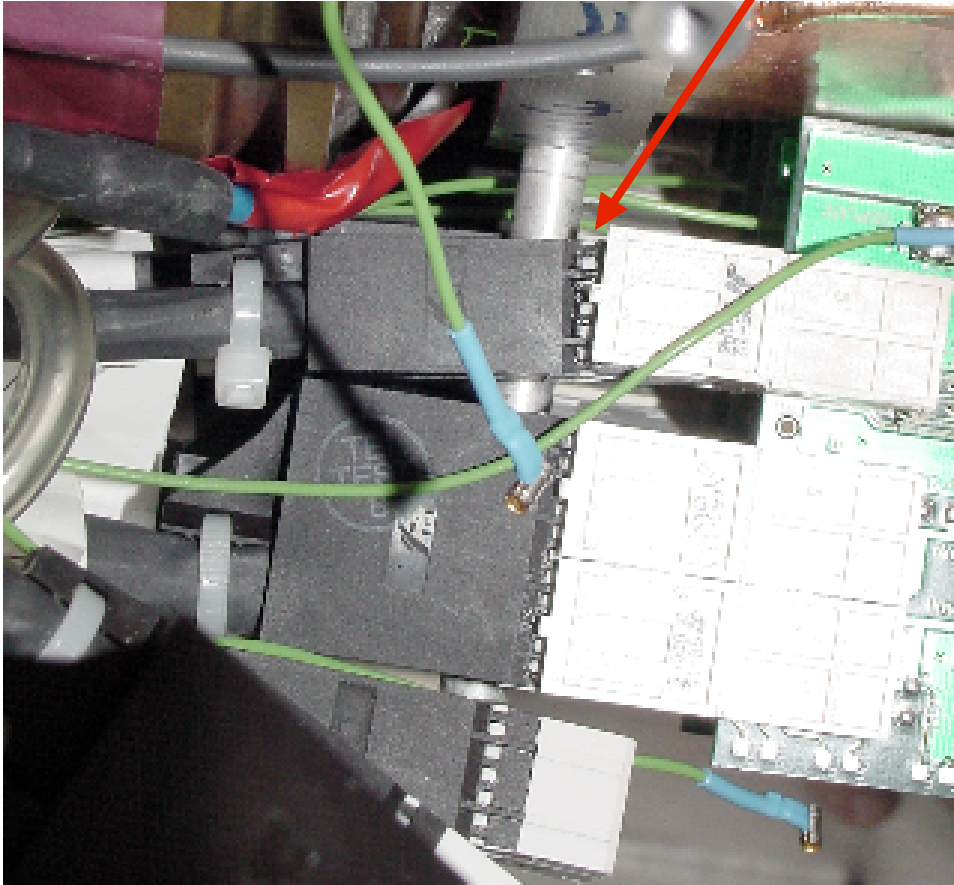
# Slipped Kapton Tails

(fixed two readout sections  
by re-inserting tails)

Rotated just a little bit...



# Connector came out...



Connector slipped out...

(fixed 1 half-module =  
2 readout sections)

Moral of this story...

Redundancy is critical, and try  
to have good connectors!

# Summary

- **The SVT works reliably as designed**
- It is more radiation hard than designed, so we can take more data
- The internal alignment is much better, taking many subtle features into account
- We recovered 6 readout sections during the shutdown this summer
- Ready for more data! (next week...)